



- 1.MATERIAL:  
 HOUSING: PBT, BLACK, UL94V-0  
 CONTACTS: 0.35[0.014] THICK PHOSPHOR BRONZE PLATED WITH 100μ" MINIMUM THICK TIN LEAD IN SOLDER AREA. 15μ" MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE CONTACTS PLATED WITH 50μ" MINIMUM THICK NICKEL.  
 SHIELDED: 0.25[0.0098] THICK COPPER ZINC ALLOY PLATED WITH 30μ" MINIMUM THICK NICKEL.
- 2.JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.

SUGGESTED PCB LAYOUT  
(COMPONENT SIDE)



PART NO. MJF13UL-KF15B34F2-0808

DWG NO. MJF13UL-KF15B34F2-0808

CHECKED BY CY

TOLERANCES ARE

DESCRIP TION:

RJ45, MODULAR JACK,  
1X1, W/O LED, 8P, 8C,  
SHIELDED, THRU-HOLE

焯倫有限公司

FILE NO.

DRAWING BY

.X ±  
.XX ±  
.XXX ±  
AWG

AREA

REVISIONS

HK

DATE

UNIT / mm

SCALE 1:1

PROJECTION

